

AMENDMENT UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
GROUP 2823
PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Docket No: Q79041
Youichi KUKIMOTO, et al.
Appln. No.: 10/765,931 Group Art Unit: 2823
Confirmation No.: 1863 Examiner: Khiem D. NGUYEN
Filed: January 29, 2004
For: SOLDER DISPOSITION METHOD AND SOLDER BUMP FORMING METHOD

AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated February 7, 2007, please amend the above-identified application as follows on the accompanying pages. A Petition for a one-month Extension of Time is being concurrently filed, extending the period of response from May 7, 2007 to June 7, 2007.

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